TOSHIBA Photocoupler GaAlAs Ired & Photo-Diode Array

TLP191B

Telecommunication
Programmable Controllers
MOS Gate Driver
MOS FET Gate Driver

The TOSHIBA mini-flat coupler TLP191B is a small outline coupler, suitable for surface mount assembly.

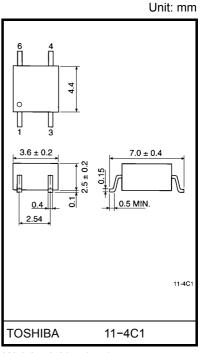
The TLP191B consists of a GaA ℓ As light emitting diode, optically coupled to a series connected photo diode array with shunt resistor which is suitable for MOS FET gate drive.

Open voltage: 7.0 V (min)
Short current: 24.0 µA (min)

Isolation voltage: 2500 Vrms (min)
UL recognized: UL1577, file no.E67349

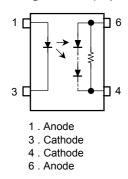
Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	l _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F / °C	-0.5	mA / °C
LED	Pulse forward current (100µs pulse, 100 pps)	I _{FP}	1	A
	Reverse voltage	V_{R}	3	V
	Junction temperature	Tj	125	°C
	Forward current	I _{FD}	50	μΑ
Detector	Reverse voltage	V_{RD}	10	V
	Junction temperature	Tj	125	°C
Storage ter	Storage temperature range		−55~125	°C
Operating temperature range		T _{opr}	-40~80	°C
Lead soldering temperature (10s)		T _{sol}	260	°C
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note)		BVS	2500	Vrms



Weight: 0.09 g (typ.)

Pin Configuration (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Start of commercial production 1990/11

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	l _F	_	20	25	mA
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	V _F	I _F = 10 mA	1.2	1.4	1.7	V
	Reverse current	I _R	V _R = 3 V	1	-	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	60	pF
Detector	Forward voltage	V _{FD}	I _{FD} = 10 μA	_	7	_	٧
	Reverse current	I _{RD}	V _{RD} = 10 V	_	7	_	μΑ
	Capacitance (anode to cathode)	C _{TD}	V = 0, f = 1 MHz			_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIn	Тур.	Max	Unit
Open voltage	V _{OC}	I _F = 20 mA	7	8	_	V
Short current	I _{SC}	I _F = 20 mA	24	40	ı	μA

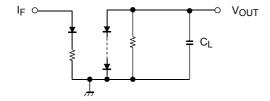
Isolation Characteristics (Ta = 25°C)

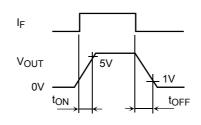
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	2500	_	_	Vrms
Isolation voltage		AC, 1 second in oil	_	5000	_	
		DC, 1 minute in oil	_	5000	-	Vdc

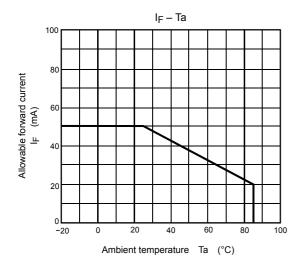
Switching Characteristics (Ta = 25°C)

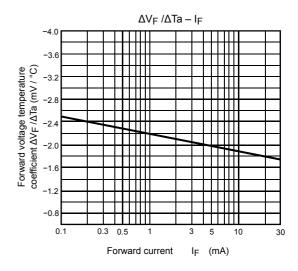
Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	t _{ON}	I _F = 20mA, C _L = 1000 pF		-	0.2	_	ms
Turn-off time	toff		(Fig.1)	-	3	1	ms

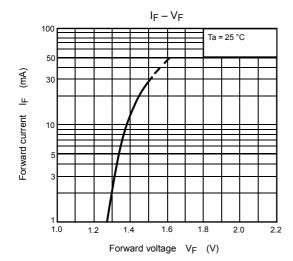
Fig. 1 Switching time test circuit

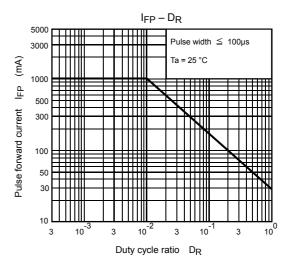


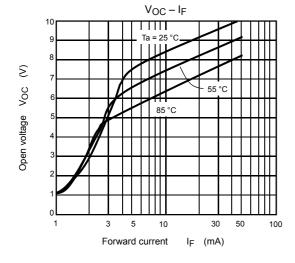


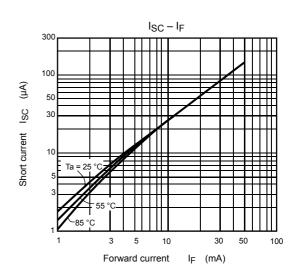












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